Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (Ultra High speed U-MOSIII)

TPCA8004-H

High Speed and High Efficiency DC-DC Converters Notebook PC Applications Portable Equipment Applications

- Small footprint due to small and thin package
- High speed switching
- Small gate charge: $Q_g = 37 \text{ nC (typ.)}$
- Low drain-source ON resistance: RDS (ON) = 3.5 m Ω (typ.)
- High forward transfer admittance: |Yfs| =80 S (typ.)
- Low leakage current: $IDSS = 10 \mu A (max) (VDS = 30 V)$
- Enhancement mode: $V_{th} = 1.1 \text{ to } 2.3 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA)}$

Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	30	V	
Drain-gate voltage (F	$R_{GS} = 20 \text{ k}\Omega$	V_{DGR}	30	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	ote 1) I _D 40		Α	
Drain current	Pulsed (Note 1)	I _{DP}	120	A	
Drain power dissipati	on (Tc=25°C)	P_{D}	45	W	
Drain power dissipati	on $(t = 10 s)$ (Note 2a)	P_{D}	2.8	W	
Drain power dissipati	on (t = 10 s) (Note 2b)	P _D	1.6	W	
Single pulse avalance	ne energy (Note 3)	EAS	208	mJ	
Avalanche current		I _{AR}	40	Α	
Repetitive avalanche	energy rc=25°C) (Note 4)	EAR	4.5	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature	range	T _{stg}	−55 to 150	°C	

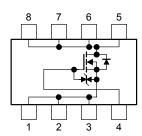
Note: For (Note 1), (Note 2), (Note 3), (Note 4), please refer to the next page.

This transistor is an electrostatic sensitive device. Please handle with caution.

Weight: 0.08 g (typ.)

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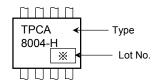
Circuit Configuration



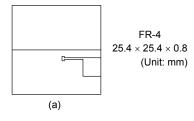
Thermal Characteristics

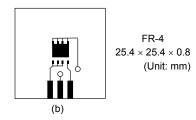
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case (Tc=25°C)	R _{th (ch-c)}	2.78	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	44.6	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	78.1	°C/W

Marking (Note 5)

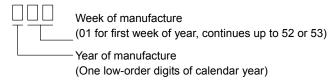


- Note 1: Please use devices on condition that the channel temperature is below 150°C.
- Note 2: (a) Device mounted on a glass-epoxy board (a)
- (b) Device mounted on a glass-epoxy board (b)





- Note 3: $V_{DD} = 24~V$, $T_{ch} = 25^{\circ}C$ (initial), L = 0.1~mH, $R_{G} = 25~\Omega$, $I_{AR} = 40~A$
- Note 4: Repetitive rating: pulse width limited by max channel temperature
- Note 5: * Weekly code: (Three digits)

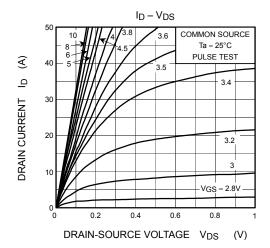


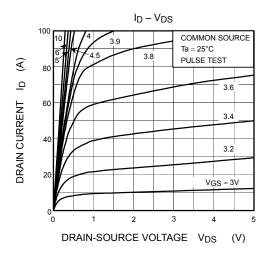
Electrical Characteristics (Ta = 25°C)

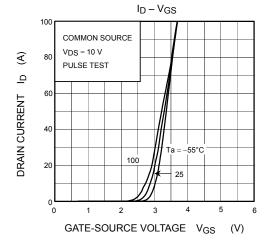
Ch	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rrent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Drain cut-OFF cu	ırrent	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	10	μА
Danier and the state of the sta		V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	30	_	_	V
Dialii-source bre	rain-source breakdown voltage		$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	15	_	_	
Gate threshold v	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.1	_	2.3	V
Drain aguras ON	raciatanas	D= 0 (01)	V _{GS} = 4.5 V, I _D = 20 A	_	4.8	6.2	
Drain-source ON resistance		R _{DS} (ON)	V _{GS} = 10 V, I _D = 20 A	_	3.5	4.6	mΩ
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 20 A	40	80	_	S
Input capacitance		C _{iss}		_	2265	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	255	_	pF
Output capacitance		Coss	_	_	1045	_	
	Rise time	tr	10 V	_	5	_	
Cuitabina tima	Turn-ON time	t _{on}	V _{GS} 10 V I _D = 20A C _G C _G	_	14	_	
Switching time	Fall time	t _f	4.7.0 3-m-4 3-m-6 N_L = 0.7	_	11	_	ns ns
	Turn-OFF time	t _{off}	$V_{DD} \simeq 15 \text{ V}$ Duty $\leq 1\%$, $t_W = 10 \mu\text{s}$	_	50	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq 24~V,~V_{GS} = 10~V,~I_D = 40~A$	_	37	_	
			$V_{DD} \simeq 24~V,~V_{GS} = 5~V,~I_D = 40~A$	_	20	_	
Gate-source charge 1		Q _{gs1}	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 40 \text{ A}$	_	8.2	_	nC
Gate-drain ("miller") charge		Q _{gd}		_	8.7	_	
Gate switch charge		Q _{SW}	1	_	12.7	_	

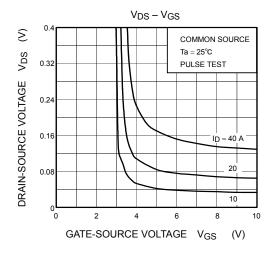
Source-Drain Ratings and Characteristics (Ta = 25°C)

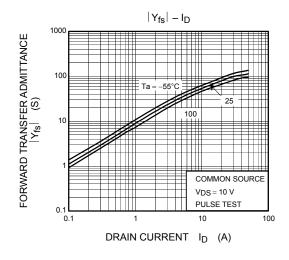
Characteri	stics		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse	(Note 1)	I _{DRP}	_	_	_	120	Α
Forward voltage (diode)			V_{DSF}	$I_{DR} = 40 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.2	V

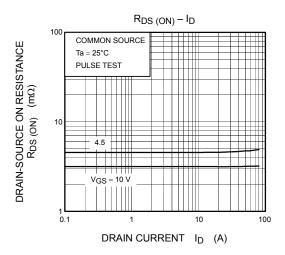


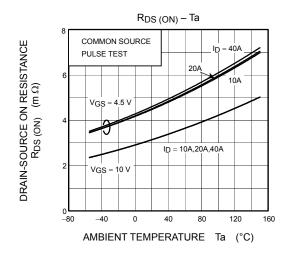


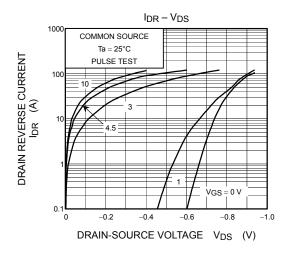


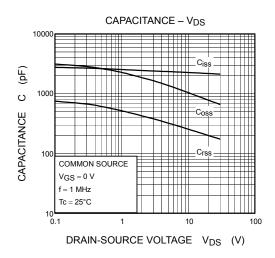


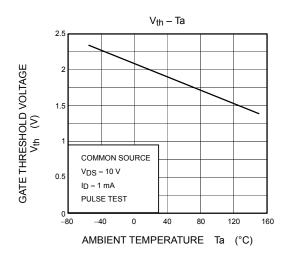


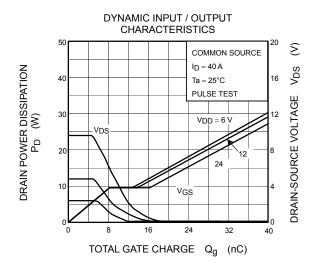




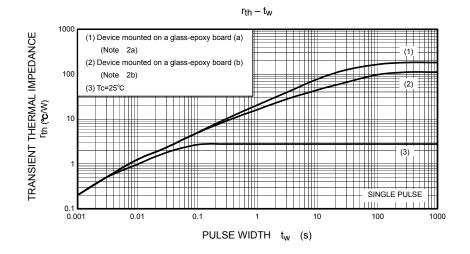


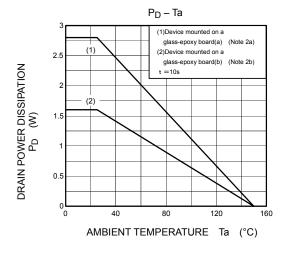


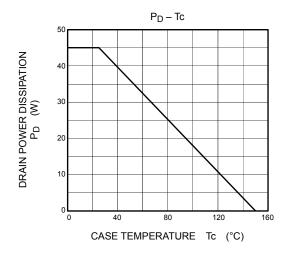


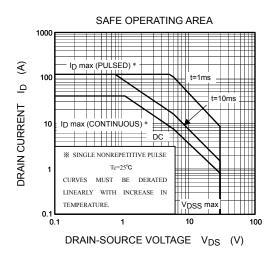


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